

## **MOSFET**

## 650V CoolMOS™ CFD7A SJ Power Device

650V CoolMOS™ CFD7A is Infineon's latest generation of market leading automotive qualified high voltage CoolMOS™ MOSFETs. In addition to the well-known attributes of high quality and reliability required by the automotive industry, the new CoolMOS™ CFD7A series provides for an integrated fast body diode and can be used for PFC and resonant switching topologies like the ZVS phase-shift full-bridge and LLC.

## **Features**

- $\bullet$  Latest 650V automotive qualified technology with integrated fast body diode on the market featuring ultra low  $Q_{\mbox{\tiny ff}}$
- Lowest FOM R<sub>DS(on)</sub>\*Q<sub>g</sub> and R<sub>DS(on)</sub>\*E<sub>oss</sub>
- 100% avalanche tested
- Best-in-class R<sub>DS(on)</sub> in SMD and THD packages

### **Benefits**

- Optimized for higher battery voltages up to 475 V thanks to further improved robustness
- Lower switching losses enabling higher switching frequencies
- · High quality and reliability
- Increased efficiency in light load and full load conditions

## Potential applications

Suitable for PFC and DC-DC stages for:

- Unidirectional and bidirectional DC-DC converters,
- On-Board battery Chargers

### **Product validation**

Qualified according to AEC Q101

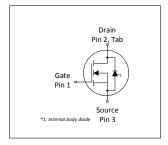
Please note: For production part approval process (PPAP) release we propose to share application related information during an early design phase to avoid delays in PPAP release. Please contact Infineon sales office.



Parameter	Value	Unit
V <sub>DS</sub>	650	V
R <sub>DS(on),max</sub>	22	mΩ
Q <sub>g,typ</sub>	234	nC
I <sub>D,pulse</sub>	495	A
E <sub>oss</sub> @ 400V	29.5	μJ
Body diode di <sub>F</sub> /dt	1300	A/µs

Type / Ordering Code	Package	Marking	Related Links
IPW65R022CFD7A	PG-TO247-3	65A022F7	see Appendix A













# 650V CoolMOS™ CFD7A SJ Power Device IPW65R022CFD7A



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## 650V CoolMOS™ CFD7A SJ Power Device IPW65R022CFD7A



1 Maximum ratings at  $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Cumbal		Value	s	l lmi4	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	96 61	А	T <sub>C</sub> =25°C T <sub>C</sub> =100°C	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	495	Α	T <sub>C</sub> =25°C	
Avalanche energy, single pulse	<b>E</b> <sub>AS</sub>	-	-	582	mJ	I <sub>D</sub> =8.3A; V <sub>DD</sub> =50V; see table 10	
Avalanche current, single pulse	I <sub>AS</sub>	-	-	8.3	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V <sub>DS</sub> =0400V	
Gate source voltage (static)	V <sub>GS</sub>	-20	-	20	V	static;	
Gate source voltage (dynamic)	V <sub>GS,pulse</sub>	-30	-	30	V	f <sub>repetition</sub> <=100kHz, t <sub>pulse</sub> <= 2ns	
Power dissipation	P <sub>tot</sub>	-	-	446	W	<i>T</i> <sub>C</sub> =25°C	
Storage temperature	T <sub>stg</sub>	-55	-	150	°C	-	
Operating junction temperature	T <sub>j</sub>	-40	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	Is	-	-	96	Α	<i>T</i> <sub>C</sub> =25°C	
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	-	-	495	Α	<i>T</i> <sub>C</sub> =25°C	
Reverse diode dv/dt <sup>3)</sup>	dv/dt	-	-	70	V/ns	$V_{DS}$ =0400V, $I_{SD}$ <=58.2A, $T_{j}$ =25°0 see table 8	
Maximum diode commutation speed	di <sub>F</sub> /dt	-	-	1300	A/μs	$V_{DS}$ =0400V, $I_{SD}$ <=58.2A, $T_{j}$ =25° see table 8	

 $<sup>^{1)}</sup>$  Limited by  $T_{j\;max}.$   $^{2)}$  Pulse width  $t_p$  limited by  $T_{j,max}$   $^{3)}$  Identical low side and high side switch with identical  $R_{\rm G}$ 

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IPW65R022CFD7A



## 2 Thermal characteristics

## **Table 3** Thermal characteristics

Davamatav	Cymbal	Values		l lmi4	Note / Took Condition		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	0.28	°C/W	-	
Soldering temperature, wavesoldering only allowed at leads	T <sub>sold</sub>	-	-	260	°C	1.6mm (0.063 in.) from case for 10s	

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## 3 Electrical characteristics

at  $T_i$ =25°C, unless otherwise specified

## Table 4 Static characteristics

For applications with applied blocking voltage > 475 V, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon.

Parameter.	Corrects of		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	650	-	-	V	$V_{GS}$ =0V, $I_{D}$ =1mA
Gate threshold voltage <sup>1)</sup>	$V_{(GS)th}$	3.5	4	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 2.91  {\rm mA}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	- 210	1 -	μА	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>j</sub> =150°C
Gate-source leakage current	I <sub>GSS</sub>	-	-	0.1	μΑ	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.018 0.04	0.022	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =58.2A, T <sub>j</sub> =25°C V <sub>GS</sub> =10V, I <sub>D</sub> =58.2A, T <sub>j</sub> =150°C
Gate resistance	R <sub>G</sub>	-	2.7	-	Ω	f=250kHz, open drain

## **Table 5** Dynamic characteristics

External parasitic elements (PCB layout) influence switching behavior significantly.

Stray inductances and coupling capacitances must be minimized.

For layout recommendations please use provided application notes or contact Infineon sales office.

Danamatan.	Ob. a.l		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C <sub>iss</sub>	-	11659	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=250kHz
Output capacitance	Coss	-	151	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=250kHz
Effective output capacitance, energy related <sup>2)</sup>	C <sub>o(er)</sub>	-	369	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =0400V
Effective output capacitance, time related <sup>3)</sup>	C <sub>o(tr)</sub>	-	3899	-	pF	$I_D$ =constant, $V_{GS}$ =0V, $V_{DS}$ =0400V
Turn-on delay time	t <sub>d(on)</sub>	-	56	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =58.2A, $R_{\rm G}$ =1.8 $\Omega$ ; see table 9
Rise time	t <sub>r</sub>	-	19	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =58.2A, $R_{\rm G}$ =1.8Ω; see table 9
Turn-off delay time	$t_{ m d(off)}$	-	198	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =58.2A, $R_{\rm G}$ =1.8 $\Omega$ ; see table 9
Fall time	t <sub>f</sub>	-	6	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =58.2A, $R_{\rm G}$ =1.8 $\Omega$ ; see table 9

<sup>1)</sup> We do not recommend using the CoolMOS mentioned in this datasheet to operate in "linear mode". For assessment of potential "linear mode", please contact Infineon sales office.

 $<sup>^{2)}</sup>$   $C_{o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V  $^{3)}$   $C_{o(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V

# 650V CoolMOS™ CFD7A SJ Power Device





 Table 6
 Gate charge characteristics

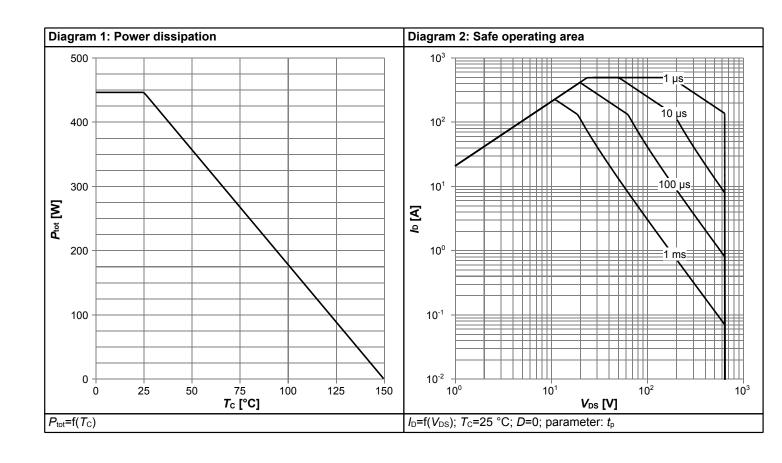
Parameter	Cumbal	Values			11	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	67	-	nC	$V_{DD}$ =400V, $I_{D}$ =58.2A, $V_{GS}$ =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	71	-	nC	$V_{DD}$ =400V, $I_{D}$ =58.2A, $V_{GS}$ =0 to 10V
Gate charge total	Qg	-	234	-	nC	$V_{DD}$ =400V, $I_{D}$ =58.2A, $V_{GS}$ =0 to 10V
Gate plateau voltage	V <sub>plateau</sub>	-	5.7	-	V	$V_{DD}$ =400V, $I_{D}$ =58.2A, $V_{GS}$ =0 to 10V

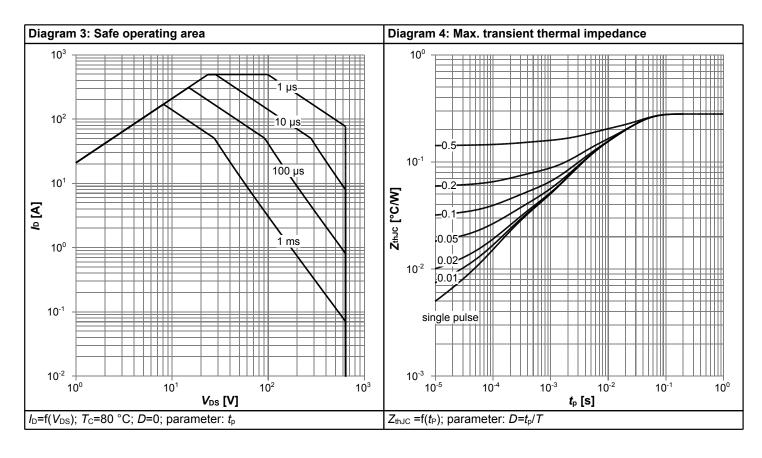
## Table 7 Reverse diode characteristics

Dovernator	Cymphal	Values			11	Nata / Tank Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	1.1	-	V	V <sub>GS</sub> =0V, I <sub>F</sub> =58.2A, T <sub>j</sub> =25°C
Reverse recovery time	t <sub>rr</sub>	-	260	-	ns	$V_R$ =400V, $I_F$ =58.2A, $di_F/dt$ =100A/ $\mu$ s; see table 8
Reverse recovery charge	Qrr	-	2	-	μC	$V_R$ =400V, $I_F$ =58.2A, $di_F/dt$ =100A/ $\mu$ s; see table 8
Peak reverse recovery current	I <sub>rrm</sub>	-	14.2	-	А	$V_R$ =400V, $I_F$ =58.2A, $di_F/dt$ =100A/ $\mu$ s; see table 8

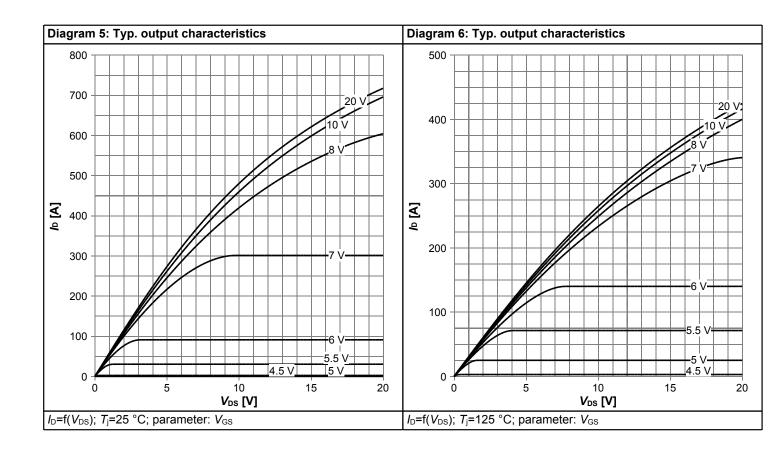


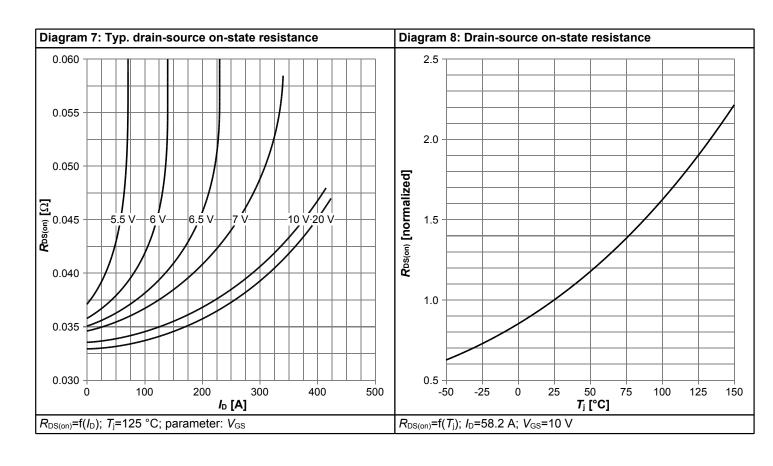
# 4 Electrical characteristics diagrams



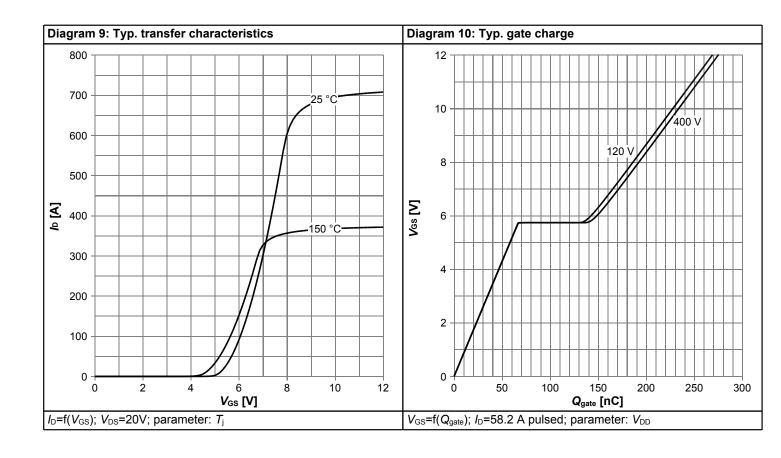


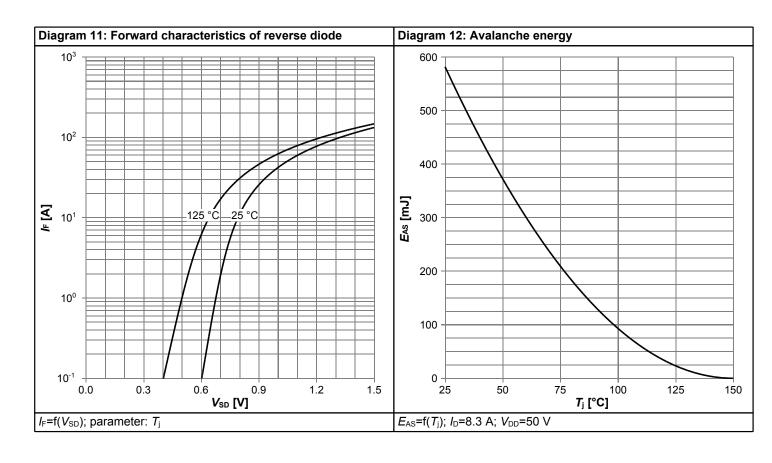




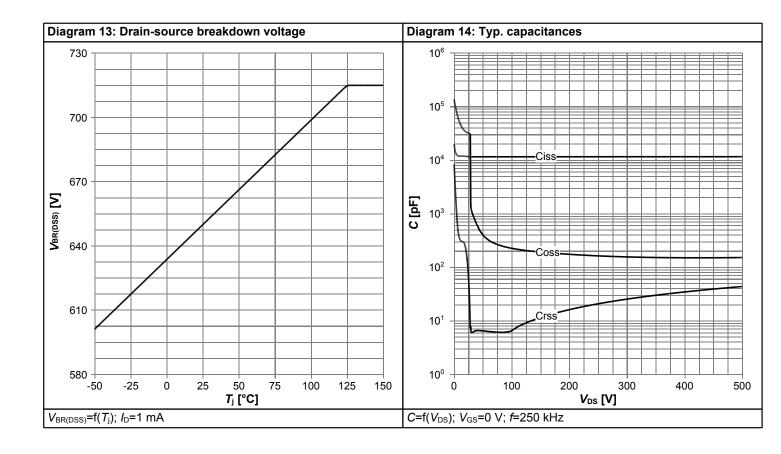


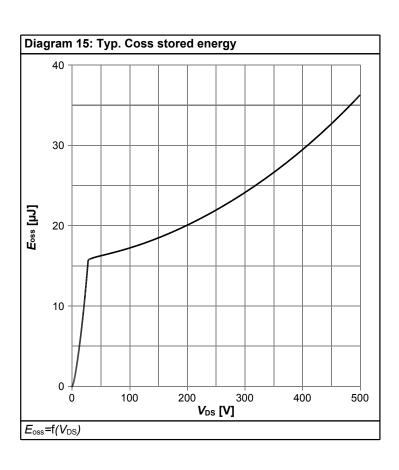














## 5 Test Circuits

**Table 8** Diode characteristics

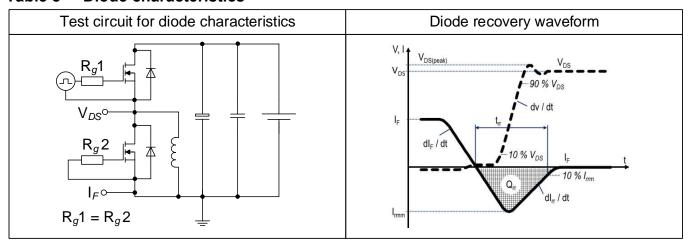


Table 9 Switching times

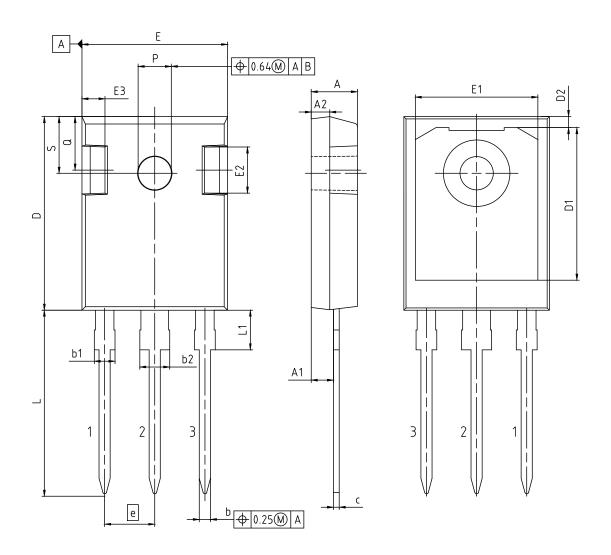


Table 10 Unclamped inductive load





# 6 Package Outlines



DIMENSIONS	MILLIM	ETERS	
DIMENSIONS	MIN.	MAX.	
Α	4.70	5.30	
A1	2.20	2.60	
A2	1.50	2.50	
b	1.00	1.40	
b1	1.60	2.41	DOCUMENT NO.
b2	2.57	3.43	Z8B00003327
С	0.38	0.89	REVISION
D	20.70	21.50	06
D1	13.08	17.65	
D2	0.51	1.35	SCALE 3:1
E	15.50	16.30	0 1 2 3 4 5mm
E1	12.38	14.15	السلسا
E2	3.40	5.10	
E3	1.00	2.60	EUROPEAN PROJECTION
е	5.	44	
L	19.80	20.40	
L1	3.85	4.50	
Р	3.50	3.70	]
Q	5.35	6.25	ISSUE DATE
S	6.04	6.30	25.07.2018

Figure 1 Outline PG-TO247-3, dimensions in mm

# 650V CoolMOS™ CFD7A SJ Power Device IPW65R022CFD7A



# 7 Appendix A

## Table 11 Related Links

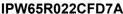
• IFX CoolMOS CFD7A Webpage: www.infineon.com

• IFX CoolMOS CFD7A application note: www.infineon.com

• IFX CoolMOS CFD7A simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

# 650V CoolMOS™ CFD7A SJ Power Device





## **Revision History**

IPW65R022CFD7A

Revision: 2021-11-22, Rev. 2.1

### **Previous Revision**

Revision	Date	Subjects (major changes since last revision)
2.0	2021-05-21	Release of final version
2.1	2021-11-22	Change of wording regarding breakdown voltage / cosmic ray

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Final Data Sheet 14 Rev. 2.1, 2021-11-22